







(Preliminary Spec)

KPGF-1012GBRC-07

1 x 1 x 0.25 mm Full-Color Surface Mount LED

DESCRIPTIONS

- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- The Blue source color devices are made with InGaN Light Emitting Diode
- The Hyper-Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- 1.0 mm x 1.0 mm SMD LED, 0.25 mm thickness
- · Low power consumption
- Package: 4000 pcs / reel
- Moisture sensitivity level: 3
- · Halogen-free
- · RoHS compliant

APPLICATIONS

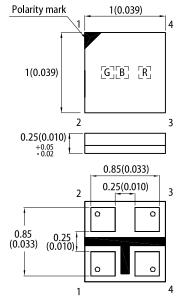
- Backlight
- Status indicator
- Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

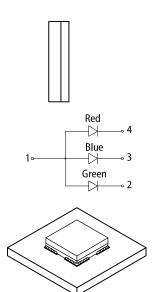
ATTENTION

Observe precautions for handling Electrostatic discharge sensitive devices

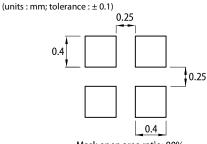


PACKAGE DIMENSIONS





RECOMMENDED SOLDERING PATTERN



Mask open area ratio: 80% Mask thickness: 80~100um

- 17. All dimensions are in millimeters (inches).
 2. Tolerance is ±0.1(0.004") unless otherwise noted.
 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
- The device has a single mounting surface. The device must be mounted according to the specifications

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 5mA [2]		Viewing Angle [1]
			Min.	Тур.	201/2
KPGF-1012GBRC-07	■ Green (InGaN)	Water Clear	80	220	150°
	■ Blue (InGaN)		10	23	
	■ Hyper Red (AlGaInP)		15	30	

Notes.
1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: +/-15%.

3. Luminous intensity value is traceable to CIE127-2007 standards.



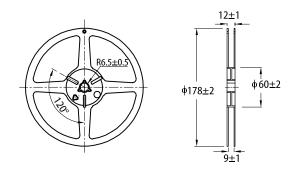
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

300 above 255°C (°C) 260°C max. 30s max. 10s max. 250 3°C/s max 6°C/s max. 200 150 Temperature pre-heating 100 150~200°C above 217°C 60~120s 60~150s 50 . 25℃ 0 50 100 150 200 250 300 (sec) Time -

4 ± 0.1 2 ± 0.1 _0.35±0.1 1.75±0.1 3.5±0.1 1.11±0.1 φ 0.5 Typ. 1.11±0.1 A-A Section

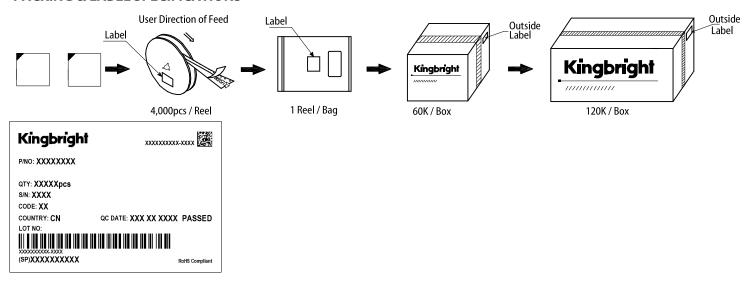
REEL DIMENSION (units: mm)

TAPE SPECIFICATIONS (units: mm)



- 1. Don't cause stress to the LEDs while it is exposed to high temperature.
 2. The maximum number of reflow soldering passes is 2 times.
 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

PACKING & LABEL SPECIFICATIONS



PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.

 The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

 The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening
- liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.

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- All design applications should refer to Kingbright application notes available at https://doi.org/10.1003/html.2013/

